



LONG CHAIN POLYAMIDE RESIN

Zytel® RS LC3060 NC010 is an unreinforced, medium viscosity, biobased polyamide 610 resin containing a minimum of 60% renewably sourced ingredients by weight, developed for extrusion applications.

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Resin Identification Part Marking Code ISO designation	PA6.10 >PA6.10< ISO 16396-PA61	ISO 1043 ISO 11469	
Rheological properties	dry/cond.		
Viscosity number	150 ^[1] /*	cm³/g	ISO 307, 1628
Intrinsic viscosity	1.33		ISO 307, 1628
Moulding shrinkage, parallel	1.4/-	%	ISO 294-4, 2577
Moulding shrinkage, normal	1.5/-	%	ISO 294-4, 2577
[1]: Sulfuric acid 96%			
Typical mechanical properties	dry/cond.		
Tensile modulus	2000/1200	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	64/52	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	5/30	%	ISO 527-1/-2
Tensile stress at break, 50mm/min	62/-	MPa	ISO 527-1/-2
Nominal strain at break	>50/>50	%	ISO 527-1/-2
Tensile strain at break, 50mm/min	230/-	%	ISO 527-1/-2
Flexural modulus	1900/1100	MPa	ISO 178
Charpy notched impact strength, 23°C	8/- 7/-	kJ/m² kJ/m²	ISO 179/1eA
Charpy notched impact strength, -40°C Izod notched impact strength, 23°C	7/- 5/20	kJ/m²	ISO 179/1eA ISO 180/1A
Hardness, Rockwell, M-scale	75/60	NJ/III	ISO 2039-2
Poisson's ratio	0.4/0.44		130 2039-2
Abrasion resistance	5.5/*	mm ³	ISO 4649
Tribological proportion	din de are d		
Tribological properties	dry/cond.		
Coefficient of static friction, against steel	-/0.23		ISO 8295
Coefficient of sliding friction, 1h against steel	-/0.31		ASTM 1894
Thermal properties	dry/cond.		
Melting temperature, 10°C/min	223/*	°C	ISO 11357-1/-3
Glass transition temperature, 10°C/min	60/50	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	55/*	°C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	155/*	°C	ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	90/*	E-6/K	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE), normal	150/*	E-6/K	ISO 11359-1/-2

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Flammability	dry/cond.		
Burning Behav. at 1.5mm nom. thickn.	HB/*	class	IEC 60695-11-10
Thickness tested	1.5/*	mm	IEC 60695-11-10
Burning Behav. at thickness h	HB/*	class	IEC 60695-11-10
Thickness tested	3/*	mm	IEC 60695-11-10
Oxygen index	24/*	%	ISO 4589-1/-2
FMVSS Class	В		ISO 3795 (FMVSS 302)
Burning rate, Thickness 1 mm	<80	mm/min	ISO 3795 (FMVSS 302)
Electrical properties	dry/cond.		
Relative permittivity, 100Hz	3.9/-		IEC 62631-2-1
Relative permittivity, 1MHz	3.3/-		IEC 62631-2-1
Dissipation factor, 100Hz	400/-	E-4	IEC 62631-2-1
Dissipation factor, 1MHz	300/-	E-4	IEC 62631-2-1
Volume resistivity	1E13/1E9	Ohm.m	IEC 62631-3-1
Comparative tracking index	600/600		IEC 60112
Dielectric Constant, 1 GHz	2.8/-		ASTM D 2520 B
Dielectric Constant, 23°C, 10 GHz	2.7/-		ASTM D 2520 B / IPC-
			TM-650
Physical/Other properties	dry/cond.		
Humidity absorption, 2mm	1.4/*	%	Sim. to ISO 62
Water absorption, 2mm	3.3/*	%	Sim. to ISO 62
Density	1070/-	kg/m³	ISO 1183

Extrusion

Drying Temperature	75 - 80 °C
Drying Time, Dehumidified Dryer	3-4 h
Processing Moisture Content	≤0.06 %
Melt Temperature Optimum	245 °C
Melt Temperature Range	240 - 255 °C

Characteristics

Processing Injection Moulding, Extrusion, Sheet Extrusion, Other Extrusion

Delivery form Pellets
Sustainability Bio-Content

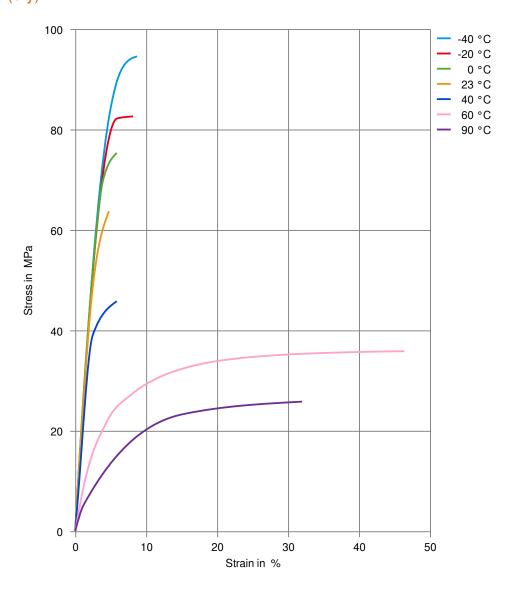
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LONG CHAIN POLYAMIDE RESIN

Stress-strain (dry)



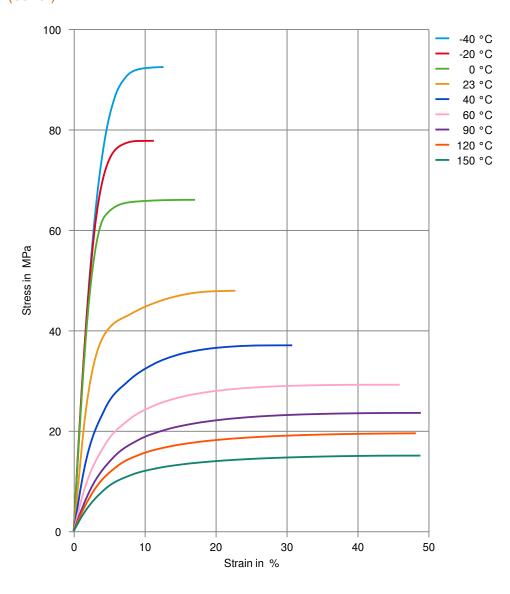
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LONG CHAIN POLYAMIDE RESIN

Stress-strain (cond.)



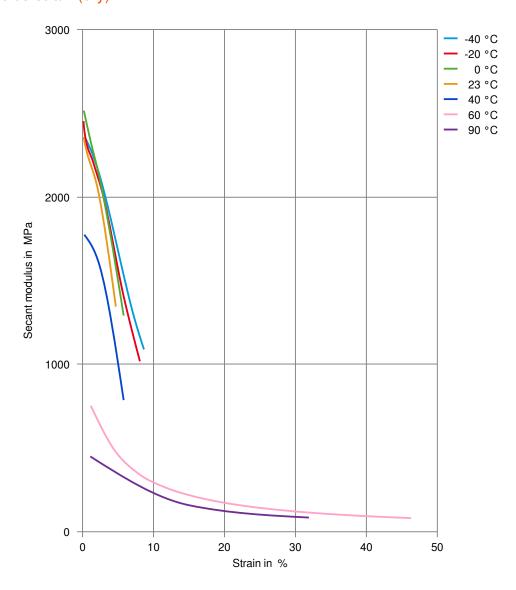
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LONG CHAIN POLYAMIDE RESIN

Secant modulus-strain (dry)



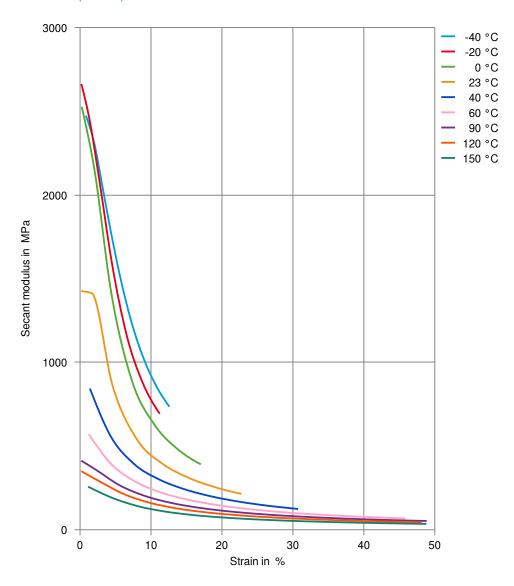
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Secant modulus-strain (cond.)



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